Image: Content Data Sheet					RoHS Every Halogen-Free				
Sales Product Name	TLE7238SL			Issued		28. August 2013			
MA#	MA000982080								
Package	PG-SSOP-24-5			Weight*		147.47 mg			
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	7.437	5.04	5.04	50432	50432	
leadframe	inorganic material	phosphorus	7723-14-0	0.016	0.01		106		
	non noble metal	zinc	7440-66-6	0.062	0.04		422		
	non noble metal	iron	7439-89-6	1.245	0.84		8445		
	non noble metal	copper	7440-50-8	50.568	34.29	35.18	342900	351873	
wire	noble metal	gold	7440-57-5	0.589	0.40	0.40	3997	3997	
encapsulation	organic material	carbon black	1333-86-4	0.166	0.11		1126		
	plastics	epoxy resin	-	7.642	5.18		51817		
	inorganic material	silicondioxide	60676-86-0	75.253	51.04	56.33	510287	563230	
leadfinish	non noble metal	tin	7440-31-5	1.680	1.14	1.14	11391	11391	
plating	noble metal	silver	7440-22-4	0.365	0.25	0.25	2477	2477	
glue	plastics	acrylic resin	-	0.539	0.37		3652		
	noble metal	silver	7440-22-4	1.909	1.29	1.66	12948	16600	
*deviation	< 10%			S	Sum in total:	100,00		1000000	

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.

2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be

proprietary, and thus CAS numbers and other limited information may not be available for release.

3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

Company	Infineon Technologies AG			
Address	81726 München			
Internet	www.infineon.com			